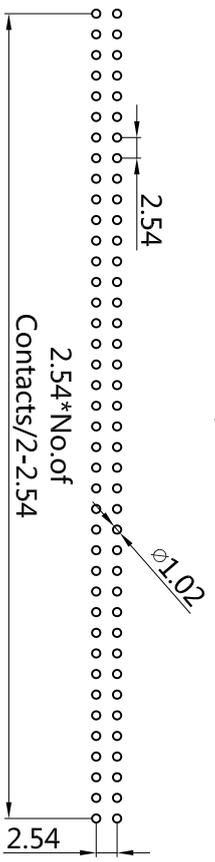
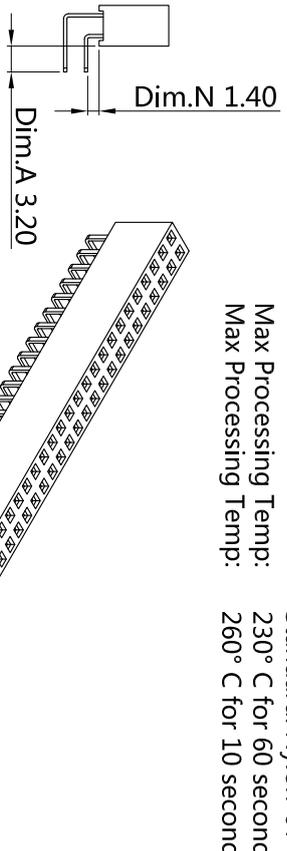
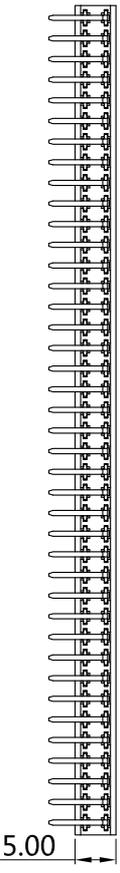
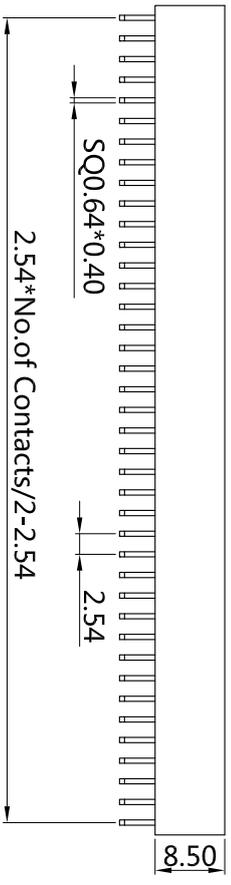
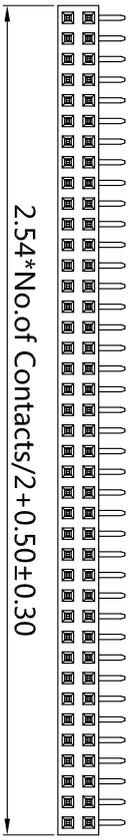


1	2	3	4	5	6	7	8
					<b>Current Rating:</b> 3 Amps <b>Insulator Resistance:</b> 1000 Megohms min <b>Contact Resistance:</b> 20 m ohms max <b>Dielectric Withstanding:</b> AC 500 V <b>Operating Temperature:</b> - 40° ~ +85° C <b>Contact Material:</b> Brass <b>Insulator Material:</b> Polyester, UL 94V-0 <b>Standard:</b> PBT <b>Finish:</b> Tin, Gold Plated <b>Standard:</b> Gold Flash all over <b>Note:</b> <b>Duplex Plating:</b> Gold Plated on contact area, Tin on solder area <b>Insulator Material:</b> Polyester, UL 94V-0 <b>Standard:</b> Nylon-6T <b>Max Processing Temp:</b> 230° C for 60 seconds <b>Max Processing Temp:</b> 260° C for 10 seconds		



Recommended P.C. Board  
SMD Layout

<b>1. Insulator material:</b> A=PBT N=PA6T P=PA9T 2. A=Phosphor Bronze B=Brass 3. Per Row:02-40PIN 4. Tail Style: R0=90° 5. Color: BK=Black	<b>6. Contact Plated:</b> T=Matte Tin over Nickel W=Matte Tin over nickel 150μ" Y=Bright Tin over Nickel C = Putin F = Gold Flash, Matte Tin 100μ" A=Gold 3μ" B=Gold 3μ" D = Gold 5μ"	<b>7.Special Options</b> <b>8. Packing:</b> A=Bag B=Tube C=Tray
<b>P1 X 85 X - 2 XX R0 BK X 000 X</b> 1 2 3 4 5 6 7 8		

<b>东莞市震升电子有限公司</b> DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD			
BOM	1:P1N85-240BKHO01	PART NO.	P1X85X-2XXR0BKX000X
	2:P1R85B-R32-Y00-C2	DRAWING NO	ZS-00104-M
	3:P1R85B-R32-Y01-C2	DRAWN BY	Deng jin quan
		APPROVAL BY	Chen xiao quang
		EDITION:	A1
		SCALE:	1:1
		UNIT:	M.M